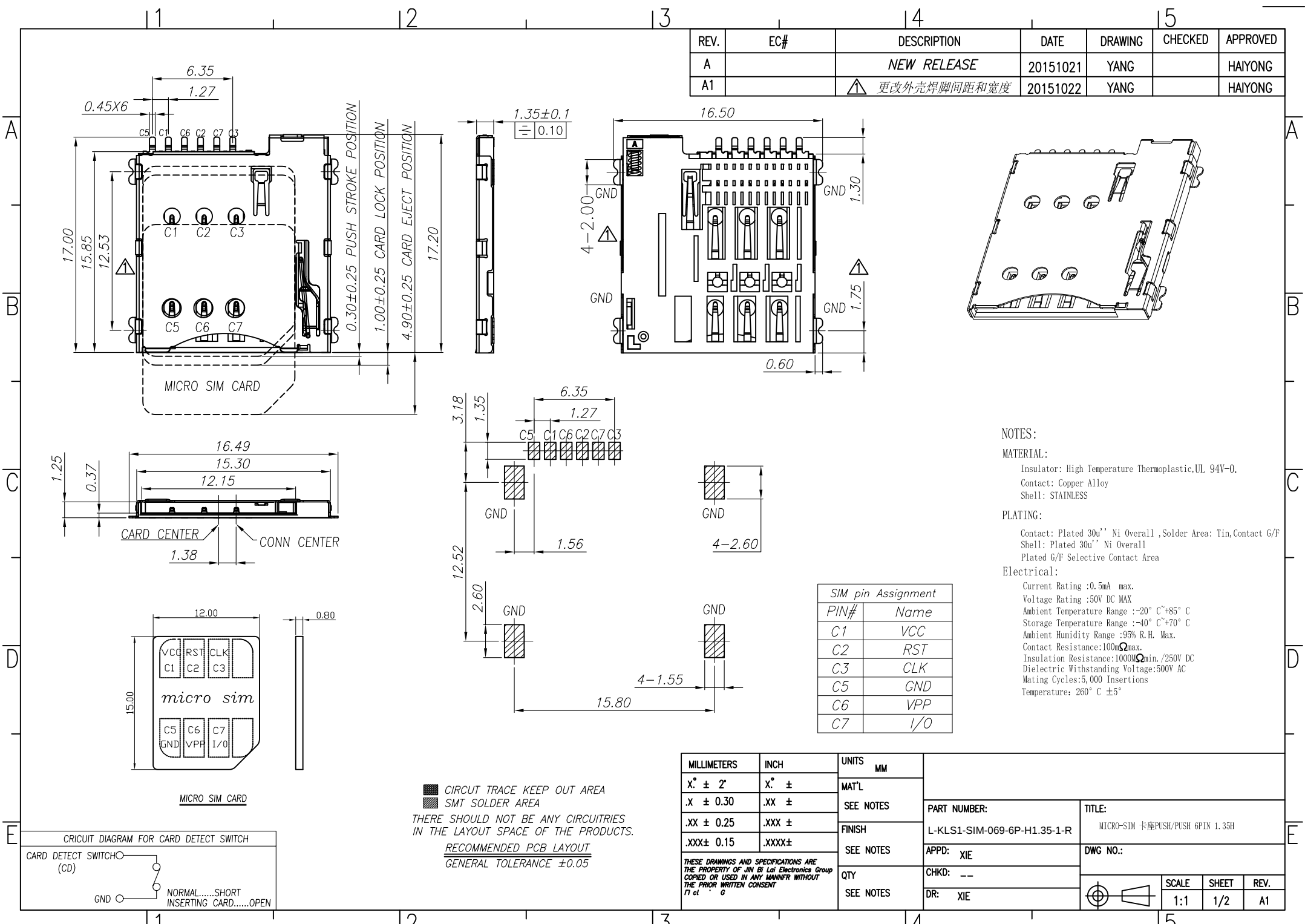


REV.	EC#	DESCRIPTION	DATE	DRAWING	CHECKED	APPROVED
A		NEW RELEASE	20151021	YANG		HAIYONG
A1		更改外壳焊脚间距和宽度	20151022	YANG		HAIYONG



NOTES:

MATERIAL:

Insulator: High Temperature Thermoplastic,UL 94V-0.

Contact: Copper Alloy

Shell: STAINLESS

PLATING:

Contact: Plated 30u'' Ni Overall ,Solder Area: Tin,Contact G/F

Shell: Plated 30u'' Ni Overall

Plated G/F Selective Contact Area

Electrical:

Current Rating :0.5mA max.

Voltage Rating :50V DC MAX

Ambient Temperature Range :~20° C~+85° C

Storage Temperature Range :~40° C~+70° C

Ambient Humidity Range :95% R.H. Max.

Contact Resistance:100mΩmax.

Insulation Resistance:1000MΩmin./250V DC

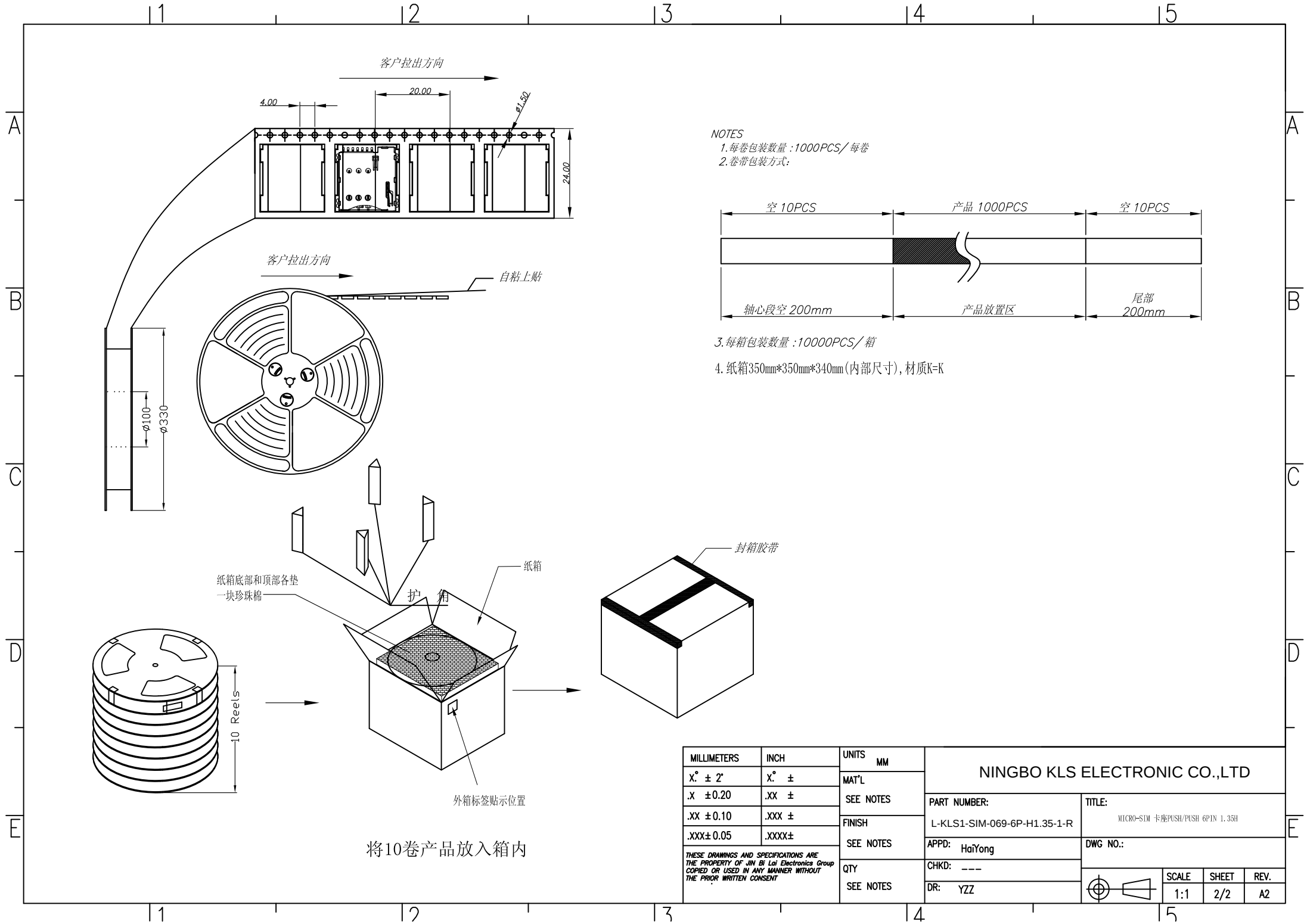
Dielectric Withstanding Voltage:500V AC

Mating Cycles:5,000 Insertions

Temperature: 260° C ±5°

SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

MILLIMETERS	INCH	UNITS				
X° ± 2'	X° ±	MM				
.X ± 0.30	.XX ±	MAT'L				
.XX ± 0.25	.XXX ±	SEE NOTES				
.XXX± 0.15	.XXXX±	FINISH				
THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF JIN BI LAI Electronics Group COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT						
QTY	SEE NOTES	DR:				
			PART NUMBER:		TITLE:	
			L-KLS1-SIM-069-6P-H1.35-1-R		MICRO-SIM 卡座PUSH/PUSH 6PIN 1.35H	
			APPD: XIE		DWG NO.:	
			CHKD: --			
			DR: XIE			
					SCALE	SHEET
					1:1	1/2
					REV.	A1



MILLIMETERS	INCH	UNITS	NINGBO KLS ELECTRONIC CO.,LTD			
X.° ± 2"	X.° ±	MM				
.X ±0.20	.XX ±	MAT'L				
.XX ±0.10	.XXX ±	SEE NOTES	PART NUMBER:		TITLE:	
.XXX±0.05	.XXXX±	FINISH	L-KLS1-SIM-069-6P-H1.35-1-R		MICRO-SIM 卡座PUSH/PUSH 6PIN 1.35H	
THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF JIN BI Lai Electronics Group COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT		SEE NOTES	APPD: HaiYong		DWG NO.:	
		QTY	CHKD: ---			
		SEE NOTES	DR: YZZ			
						SCALE
				1:1	2/2	A2